

ABSTRACT

The present invention addresses the problem of providing a technology enabling to improve mounting efficiency. As a means for solving the problem, a sheet (22) having a component (21) stuck thereto is held by having a space between the sheet (22) and a substrate (20). Then, the sheet (22) is warped and the component (21) is brought into contact with the substrate (20) by pressing, via the sheet (22), the component (21) by means of a plunger (31). Then, a pin (32) relatively protrudes from the plunger (31) by moving the plunger (31) to the inner side of a mounting head (10).